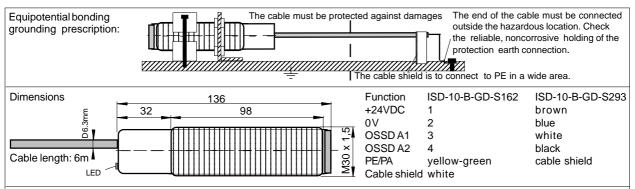
Tippkempe	•
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GARDIX fail-safe inductive sensor ISD-10-B-GD-S162/293(-GD)

Safety device according to the machine directive 2006/42/EC, short form data sheet When installing and operating the sensor, it is necessary to take into consideration the complete operating manual.

	 Housing M30, embeddable mounting method (flush mount PDDB according to EN 60947-5-3 For use in Ex Zones 1, 2, 21, 22
	x designation:
	IIC T5 Gb
	IIIC T100°C Db IP67
Technical Data Type	ISD-10-B-GD-S162/S293
Type	SRP/CS - SREC, fail-safe inductive sensor PDDB, I1A30AP1
Performance Level (PL), EN 13849-1	PL e
Safety category, EN 13849-1 Safety integrity level, EN 62061	SILCL 3
Safety-related reliability PFHd [1/h]	2.47 x 10-8
MTTFd [Years]	100
DC/CCF/Cat.	99% / 92 / 4
Type of Ex protection Gas, directive 2014/34/EU	II 2G Ex db IIC T5 Gb
Type of Ex protection Dust, directive 2014/34/EU	II 2D Ex to IIIC T100°C Db IP67
Only for use in Ex zones	1, 2, 21, 22
Installation method	embaddable (flush) mountable
Rated operating distance sn,	10mm, (on steel 37, (sn x 3) ² x 1mm), at non flush mounting, at EN 60947-2-5
Enable zone	>=3mm <=8mm, (on steel 37, (30mm x 30mm x 1mm)
Hysteresis	0.5-1.5mm
Safe switching off distance s(ar)	30mm
Repeatability	<100um
Utilzation category	DC 13
Supply voltage Ue	24VDC +-10% (Power supply type PELV according to EN 60204, item 6.4.2)
Absolute maximum supply voltage Um	30VDC
Rated insulation voltage	75VDC/50VAC
Current consumption	35mA
Maximum power dissipation	0.98W
Response time to safety request	20ms
Power up delay time OSSD	200ms 2 x PNP (A1 and A2)
Output voltage at 24 V	compatible with EN 61131-2 inputs type 1, 2, 3
Voltage drop	2V, (70mA)
Current rating	70mA
Short-circuit protection	yes
Display	LED green (OSSD=ON), LED red (OSSD=OFF)
Housing, type ISD-10B-GD-S162	M30, brass, nickel plated / Sensing area: Synthetic, PEEK mod.
Housing, type ISD-10B-GD-S293	M30, stainless steel 316ss / Sensing area: Synthetic, PEEK mod.
Enclosure rating, according to EN 60529	IP67
Ambient working temperature range Tamb	-10°C < Tamb < +50°C
Storage temperature range	-45°C +70°C
EMC, shock and vibration resistance	according to EN 60947-5-2
Connection cable, type ISD-10-B-GD-S162	4+PE x 0,5mm ² , TPU jacket, shielded, leads numbering marked, halogen-free,
	diameter: 6.3mm, length: 6m
Connection cable, type ISD-10-B-GD-S293	4 x 0,22mm ² , shielded, FEP/silicone rubber, leads color-marked, dia. 4,4mm, length: 6
Cable, minimum bending radius	70mm
Accessories Options	- 2x nuts M30. (Optional 1x clamp) - Other cable lengths on request
_ED indication	Object detected, LED green Object detected, LED red
ED indication Output with dynamic test function	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON + VDC	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON + VDC	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON + VDC	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open.
ED indication Output with dynamic test function Object detected, Outputs switched ON + VDC	2 x PNP-Outputs, Transistors conducted.
ED indication Output with dynamic test function Object detected, Outputs switched ON + VDC	2 x PNP-Outputs, Transistors conducted. 2 x PNP-Outputs, Transistors open. 1 1 1 1
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Operating manual, short form, EC-/EU-Declaration of Conformity:

Accident prevention: **Definite Application:**

The PDDB ISD-10-B(-GD) is a fail-safe inductive sensor conform the machine directive 2006/42/EC. The sensor detects non-contact metallic objects and is provided for the protection of humans and machines. The outputs (OSSD) will be only unblocked, when metallic objects are detected in the enable range. The fail-safe inductive sensor must only be operated with fail-safe relay or other fail-safe equipment. When installing and operating the sensor, it is necessary to take into consideration the complete operating manual. The sensor must be installed, connected and put into operation only by qualified electrician trained in safety technology. The outputs (OSSD) must not be connected direct to the machinery circuit. The outputs (OSSD) of the sensor must only be connected at emergency stop relay or other approved electronic safety devices. The installation must be protected against defeating. The sensor reacts to metal objects, e.g. the frame of a safety door. Other metal objects that are intended to enable the sensor must not be allowed to enable the sensor, either intentionally or unintentionally. Use the sensor only in the specified environmental conditions. The sensor must only be repaired by the manufacturer. Tampering with the sensor is not allowed. Disconnect the sensor externally before handling it. Also disconnect any supplied relay load circuits. The applicable standards for the corresponding application must be complied with. For installations the requirements according to EN 60204 must be observed. After power-up a complete function and safety test must be executed. Also without supply voltage, leaking currents up to 2mA are possible. All connections and installations must be executed at safety fundamental rules. It must be ensured, that the machinery residuals off after a safe switch-off or a defect of the sensor

Installation prescriptions for Ex hazardous locations:

It is necessary to take into consideration the valid international and national rules and regulations (EN 60079-14). Do not exceed the maximum ratings. The local equipotential bonding have to be done. The protective earth (PE/ PA) is solid connected with the housing and the cable shielding. The cable have to be installed and protected against damages. The cable with termination fittings, or in cable tray systems and installed in a manner to avoid tensile stress at the termination fittings. To connect cables inside hazardous locations only use certificated Ex e housings. All cable terminals must be connected outside hazardous locations. The maximum rated input voltage Um = 30VDC must not be exceeded.

Type ISD-10-B-GD: Only for use in Ex zones 1, 2, 21, 22.

Additional safety information related Ex protection:

BVS 07 ATEX E 044 X: X = The plastic part of the housing (sensitive area) must be protected against direct sunlight and UV irradiation.

General mounting prescriptions:

It must be ensured that all requirements of the respective application correspond to the requirements stated in these and the complete operating manual instructions. The sensor can only be flush mounted. Because the sensor reacts to metal objects, it must be ensured, that other metal objects not can enable the sensor, either intentionally or unintentionally (EN 1088). A horizontal mounting is to prefer. Lateral protection plates must not rise above the sensor. Metallic protection plates must not rise above the sensor. Electrolytic fluids, graphitized greases or other magnetizable substances can disturb the correct function. All post-switched circuits must also be certificated for the required safety level. The electrical connections must be exactly as shown in the connection diagram. The cable shield must be connected short. The cable shield should be connected to the protection earth, large-surfaced. Connection cables must not be installed parallel to high voltage cables. The maximum allowed capacitance at the outputs must be <= 470nF.

Function:

e2/2017-09-26/HB

S162-IECEX

SD-10-B-GD-

When a metallic object is entering the detection field, both dynamic tested outputs (OSSD) becomes active (switching ON). Is no object detected both outputs becomes inactive (safe state, OFF). If metallic or other permeable objects are positioned near or direct (<=3mm) on the sensitive area of the sensor, both outputs are also switching OFF. The fail-safe inductive sensors of the series ISD-10-B(-GD) are built in a 2-channel

different redundancy. Failures and disturbances results to outputs are switching OFF and the LED is blinking red. The safe-state is the same as no object is detected. (Output is switching OFF). The emergency OFF state is only resetable by separating the supply voltage.

Chemical resistance:

The sensor must not be exposed to the following substances: Formic Acid, Chlorosulfonic Acid, Chronic Acid conc., Hydrochloric Acid, Hydrobromic Acid (100%), Oluem, Azotic Acid, Sulphuric Acid, Bromine, Chlorine, Ferric(III)-chlorid, Fluorine, Iodine, Sodium (hot), concentrated Phenol,

Maintenance:

The sensor does not require any special maintenance. Magnetic precipitations must be cleared. Equipment must only be repaired or serviced by the manufacturer

General notes to the operating distance:

The nominal operating distance sn (EN60947-2-5) does not take into account production tolerances and influences of temperature or voltage. The safe operating distance sa is the minimal reachable operating distance on steel 37 (30mmx30mmx1mm) on all mounting arrangements. On other materials or smaller objects a reduction factor must be taken into account

Material	Reduction factor
Steel 37	1
Stainless steel	0,8
Aluminum	0.4

Safety distance sd: An inductive sensor is safe switched OFF, when the distance between sensor and actuator plate is greater then 3 x nominal distance sn.

General safety instructions:

Small or bad magnetizable parts, placed direct on or near the sensitive area results not to the near range switching-off.

When installing and operating with the sensor, it is necessary to take into consideration the relevant international and other national regulations: EN 60204, EN 60079-14, single directive 1999/92/EC

The sensors are conform to the following directives and standards: Machine directive: 2006/42/EC, ATEX directive: 2014/34/EU, EMC directive: 2014/30/EU, RoHS directive: 2011/65/EU, EN 60947-5-1/A2:2015-05, EN 60947-5-2:2014-01, EN 60947-5-3:2014-12, EN 13849-1/A1:2013-09, EN 62061/A2:2015-02; EN 60079-0:2012 + A11:2013, EN 60079-1:2014, EN 60079-31: 2014, EN 60529:2014, EN 61326-3-1:2015-06.

General notes, disposal:

We reserve the right to modify our equipment. Our equipment is designed in accordance with the RoHS directive. It neither emit or contain any damaging or siliconized substances and use a minimum of energy and resources. No longer usable or irreparable units must be disposed of in accordance with local waste disposal regulations.

EC-/EU Declaration of conformity, short-form

Approvals:

Fail-safe: PDDB in accordance with EN 60947-5-3, certification number: ET 17036, Berufsgenossenschaft Energie Textil Elektro Medienerzeugnisse, Fachausschuss Elektrotechnik, Prüf- und Zertifizierungsstelle im DGUV Test, Gustav-Heinemann-Ufer 130, D-50968 Köln, CE 0340. IECEx certification, type ISD: Ex db IIC T5 Gb, Ex ta/tb IIIC T100°C Da/

Db IP67. Certification No. IECEx BVS 14.0108X. cex.iec.ch/iecex/iecexweb.nsf/0/FE79714C0BAEF6F5C1257D7E0044F6A9?opendocumen

ATEX certification, type ISD: II 2G Ex db IIC T5 Gb, II 1/2D Ex ta/tb IIIC T100°C Da/Db IP67. Certification number: BVS 07 ATEX E 044 X, DEKRA EXAM GmbH, Zertifizierungsstelle, Carl-Beyling-Haus, Dinendahlstrasse9, D-44809 Bochum, CE 0158.

ATEX certification of quality type production of Ex devices according to the ATEX directive 2014/34/EU, CE 0158. Certification No: BVS 15 ATEX ZQS /E118. The conformity of the devices with the EC standards and directives and the EC-type examination certificate and the observation of the Quality Management System ISO 9001:2008 with the ATEX module "Production" declares:

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Hans Bracher, Matrix Elektronik AG

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